

2.52

RECOMMENDED LAND PATTERN

WDFN8 3x3, 0.65P CASE 511DD ISSUE O

DATE 31 JUL 2016

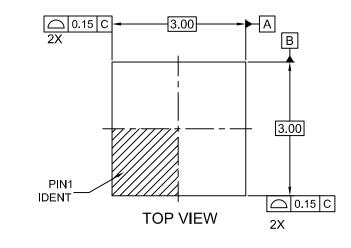
1.94

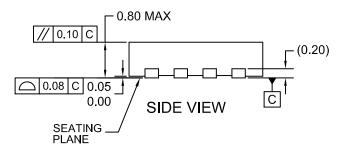
3.30

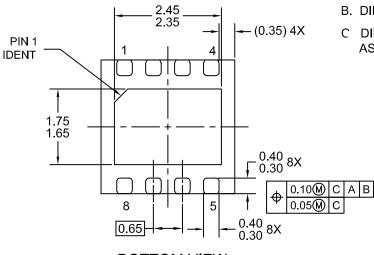
5

4

0.47 8X







BOTTOM VIEW

NOTES:

- A: PACKAGE CONFORMS TO JEDEC MO-229 EXCEPT WHERE NOTED.
- B. DIMENSIONS ARE IN MILLIMETERS.

1.70

0.65

0.56 8X

ł

C DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.

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